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Vishay Siliconix

Automotive P-Channel 80 V (D-S) 175 °C MOSFET



Marking Code: TC

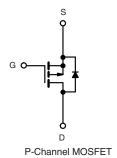
PRODUCT SUMMARY				
V _{DS} (V)	-80			
$R_{DS(on)}(\Omega)$ at $V_{GS} = -10 \text{ V}$	0.290			
$R_{DS(on)}(\Omega)$ at $V_{GS} = -6 \text{ V}$	0.314			
I _D (A)	-2.2			
Configuration	Single			

FEATURES

- TrenchFET® Power MOSFET
- AEC-Q101 Qualified
- 100 % R_q and UIS Tested
- Material categorization: for definitions of compliance please see www.vishay.com/doc?99912







ORDERING INFORMATION	
Package	SOT-23
Lead (Pb)-free and halogen-free	SQ2337CES (for detailed order number please see www.vishay.com/doc?79771)

ABSOLUTE MAXIMUM RATINGS (T _C = 25 °C, unless otherwise noted)					
PARAMETER		SYMBOL	LIMIT	UNIT	
Drain-source voltage		V_{DS}	-80	.,	
Gate-source voltage		V _{GS}	± 20	V	
Continuous drain current	T _C = 25 °C		-2.2		
Continuous drain current	T _C = 125 °C	l _D	-1.3		
Continuous source current (diode conduction)	Is	-3.7	Α		
Pulsed drain current ^a	I _{DM}	-9			
Single pulse avalanche current	L = 0.1 mH	I _{AS}	-11		
Single pulse avalanche energy		E _{AS}	6	mJ	
Maximum power dissipation	T _C = 25 °C	D	3	W	
	T _C = 125 °C	- P _D	1	VV	
Operating junction and storage temperature range		T _J , T _{stg}	-55 to +175	°C	

THERMAL RESISTANCE RATINGS					
PARAMETER		SYMBOL	LIMIT	UNIT	
Junction-to-ambient	PCB mount b	R _{thJA}	166	°C/W	
Junction-to-foot (drain)		R _{thJF}	50	C/VV	

Notes

- a. Pulse test; pulse width $\leq 300~\mu s,~duty~cycle \leq 2~\%$
- b. When mounted on 1" square PCB (FR-4 material)



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PARAMETER	SYMBOL	TEST CONDITIONS		MIN.	TYP.	MAX.	UNIT
Static							
Drain-source breakdown voltage	V_{DS}	V _{GS} = 0, I _D = -250 μA		-80	-	-	V
Gate-source threshold voltage	V _{GS(th)}	V _{DS} =	V_{GS} , $I_{D} = -250 \mu\text{A}$	-1.5	-2.0	-2.5	V
Gate-source leakage	I _{GSS}	V _{DS} =	$V_{DS} = 0 \text{ V}, V_{GS} = \pm 20 \text{ V}$		-	± 100	nA
	I _{DSS}	$V_{GS} = 0 V$	V _{DS} = -80 V	-	-	-1	μΑ
Zero gate voltage drain current		V _{GS} = 0 V	V _{DS} = -80 V, T _J = 125 °C	-	-	-50	
		V _{GS} = 0 V	V _{DS} = -80 V, T _J = 175 °C	-	-	-150	
On-state drain current ^a	I _{D(on)}	V _{GS} = -10 V	$V_{DS} \ge 5 V$	-8	-	-	Α
Daile and a state of the second		V _{GS} = -10 V	I _D = -1.2 A	-	0.241	0.290	Ω
Drain-source on-state resistance a	R _{DS(on)}	V _{GS} = -6 V	I _D = -1.1 A	-	0.261	0.314	
Forward transconductance b	9fs	V _{DS} =	-15 V, I _D = -1.2 A	-	3.5	-	S
Dynamic ^b						•	
Input capacitance	C _{iss}			-	382	620	
Output capacitance	C _{oss}	V _{GS} = 0 V	V _{GS} = 0 V V _{DS} = -40 V, f = 1 MHz		39	55	рF
Reverse transfer capacitance	C _{rss}	1		-	23	38	
Total gate charge c	Q_{g}			-	9.3	18	nC
Gate-source charge ^c	Q_{gs}	V _{GS} = -40 V	$V_{DS} = -40 \text{ V}, I_{D} = -1.2 \text{ A}$	-	1.6	-	
Gate-drain charge ^c	Q_{gd}	1		-	2.2	-	
Gate resistance	R_g	f = 1 MHz		2.2	4.2	7	Ω
Turn-on delay time ^c	t _{d(on)}			-	8	12	
Rise time °	t _r	V _{DD} =	-40 V, R_L = 41.6 Ω	-	3	15	
Turn-off delay time ^c	t _{d(off)}	I _D ≅ -0.96 A	$I_D \cong -0.96 \text{ A}, V_{GEN} = -40 \text{ V}, R_g = 1 \Omega$		18	27	- ns
Fall time ^c	t _f		1	4	12		
Source-Drain Diode Ratings and Characte	eristics ^b					•	
Pulsed current ^a	I _{SM}				-	- 9	Α
Forward voltage	V_{SD}	I _F = -0.8 A, V _{GS} = 0		1	-0.8	-1.2	V
Body diode reverse recovery time	t _{rr}	I _F = -1.2 A, di/dt = 100 A/μs		-	25	50	ns
Body diode reverse recovery charge	Q _{rr}			-	30	60	nC
Reverse recovery fall time	ta			-	23	-	ns
Reverse recovery rise time	t _b			-	2	-	115
Body diode peak reverse recovery current	I _{RM(REC)}			-	-3.5	-	Α

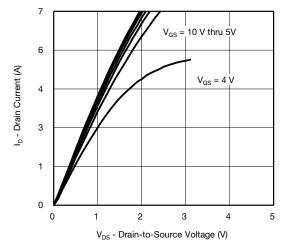
Notes

- a. Pulse test; pulse width \leq 300 μ s, duty cycle \leq 2 %
- b. Guaranteed by design, not subject to production testing
- c. Independent of operating temperature

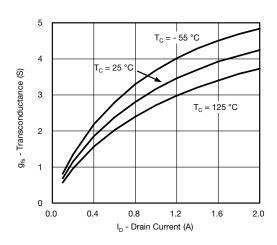
Stresses beyond those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated in the operational sections of the specifications is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.



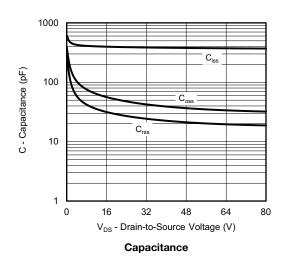
TYPICAL CHARACTERISTICS (T_A = 25 °C, unless otherwise noted)

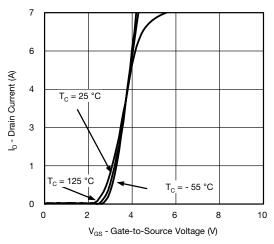


Output Characteristics

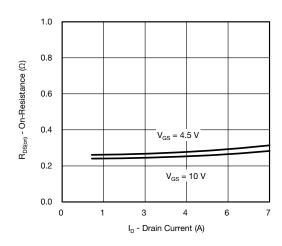


Transconductance

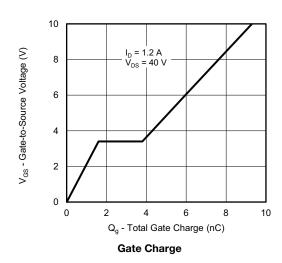




Transfer Characteristics

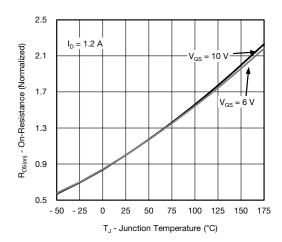


On-Resistance vs. Drain Current

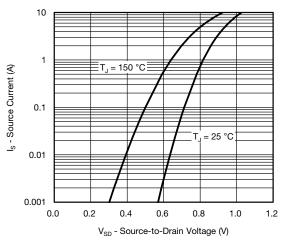




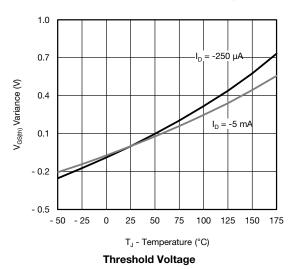
TYPICAL CHARACTERISTICS (T_A = 25 °C, unless otherwise noted)

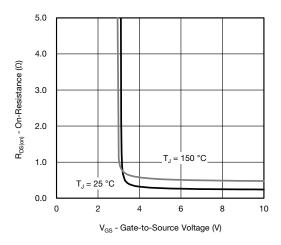


On-Resistance vs. Junction Temperature

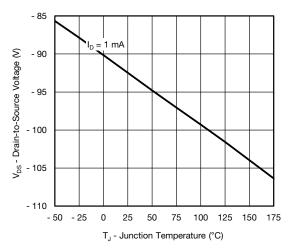


Source-Drain Diode Forward Voltage

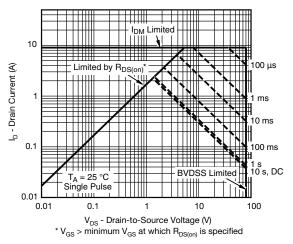




On-Resistance vs. Gate-to-Source Voltage



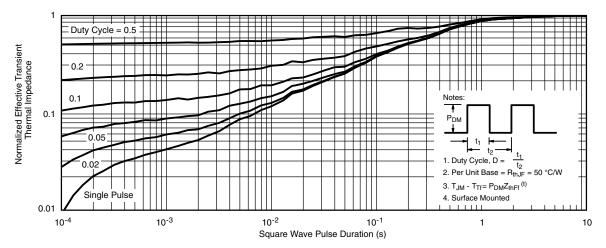
Drain Source Breakdown vs. Junction Temperature



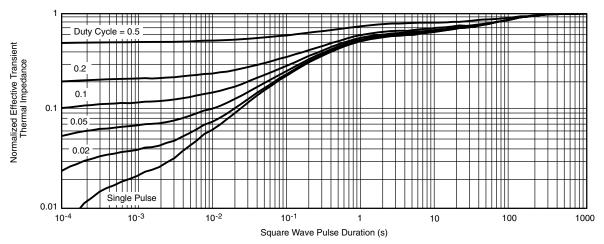
Safe Operating Area



THERMAL RATINGS (T_A = 25 °C, unless otherwise noted)



Normalized Thermal Transient Impedance, Junction-to-Foot



Normalized Thermal Transient Impedance, Junction-to-Ambient

Note

- The characteristics shown in the two graphs
 - Normalized Transient Thermal Impedance Junction-to-Ambient (25 °C)
 - Normalized Transient Thermal Impedance Junction-to-Case (25 °C)

are given for general guidelines only to enable the user to get a "ball park" indication of part capabilities. The data are extracted from single pulse transient thermal impedance characteristics which are developed from empirical measurements. The latter is valid for the part mounted on printed circuit board - FR4, size 1" x 1" x 0.062", double sided with 2 oz. copper, 100 % on both sides. The part capabilities can widely vary depending on actual application parameters and operating conditions

Vishay Siliconix maintains worldwide manufacturing capability. Products may be manufactured at one of several qualified locations. Reliability data for Silicon Technology and Package Reliability represent a composite of all qualified locations. For related documents such as package / tape drawings, part marking, and reliability data, see www.vishay.com/ppg262457.

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SOT-23 (TO-236): 3-LEAD







Dim	MILLI	METERS	INCHES		
	Min	Max	Min	Max	
Α	0.89	1.12	0.035	0.044	
A ₁	0.01	0.10	0.0004	0.004	
A ₂	0.88	1.02	0.0346	0.040	
b	0.35	0.50	0.014	0.020	
С	0.085	0.18	0.003	0.007	
D	2.80	3.04	0.110	0.120	
E	2.10	2.64	0.083	0.104	
E ₁	1.20	1.40	0.047	0.055	
е	0.95 BSC		0.0374 Ref		
e ₁	1.90 BSC		0.0748 Ref		
L	0.40	0.60	0.016	0.024	
L ₁	0.64 Ref		0.025 Ref		
S	0.50 Ref		0.020 Ref		
q	3°	8°	3°	8°	
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RECOMMENDED MINIMUM PADS FOR SOT-23



Recommended Minimum Pads Dimensions in Inches/(mm)

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APPLICATION NOTE



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